



#### N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

| V <sub>(BR)DSS</sub> | R <sub>DS(ON)</sub>          | I <sub>D</sub><br>T <sub>A</sub> = +25°C |
|----------------------|------------------------------|--|
| 240V                 | 11Ω @ V <sub>GS</sub> = 10V  | 0.27A                                    |
| 2400                 | 12Ω @ V <sub>GS</sub> = 4.5V | 0.26A                                    |

## **Description**

This new generation MOSFET has been designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

- DC-DC Converters
- Power management functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc

### **Features and Benefits**

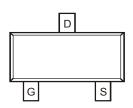
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

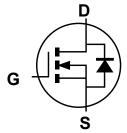
- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 @3
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Terminal Connections: See Diagram
- Weight: 0.006 grams (approximate)







Top View Pin Configuration



**Equivalent Circuit** 

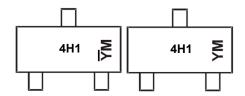
### Ordering Information (Note 4)

| Part Number   | Case  | Packaging          |
|---------------|-------|--------------------|
| DMN24H11DS-7  | SOT23 | 3,000/Tape & Reel  |
| DMN24H11DS-13 | SOT23 | 10,000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



4H1 = Product Type Marking Code

YM = Date Code Marking for SAT (Shanghai Assembly/ Test site)

YM = Date Code Marking for CAT (Chengdu Assembly/ Test site)

 $Y \text{ or } \overline{Y} = Y \text{ ear } (ex: Y = 2011)$ 

M = Month (ex: 9 = September)

Date Code Key

| Year  | 201 | 1   | 2012 |     | 2013 | 20  | 14  | 2015 |     | 2016 | - : | 2017 |
|-------|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Code  | Υ   |     | Z    |     | Α    | [   | 3   | С    |     | D    |     | E    |
| Month | Jan | Feb | Mar  | Apr | May  | Jun | Jul | Aug  | Sep | Oct  | Nov | Dec  |
| Code  | 1   | 2   | 3    | 4   | 5    | 6   | 7   | 8    | 9   | 0    | N   | D    |

DMN24H11DS Document number: DS37092 Rev. 3 - 2



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic  | Symbol           | Value        | Units |
|---|------------------|--------------|-------|
| Drain-Source Voltage                                    | $V_{DSS}$        | 240          | V     |
| Gate-Source Voltage                                     | V <sub>GSS</sub> | ±20          | V     |
| Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V | I <sub>D</sub>   | 0.27<br>0.22 | А     |
| Pulsed Drain Current (10µs pulse, duty cycle ≦1%)       | I <sub>DM</sub>  | 0.8          | Α     |
| Maximum Body Diode Continuous Current (Note 5)          | I <sub>S</sub>   | 0.8          | Α     |
| Peak diode recovery dv/dt                               | dv/dt            | 6.0          | V/ns  |

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic                          | Symbol   | Value                            | Units       |      |  |
|---|----------|----------------------------------|-------------|------|--|
| Total Power Dissipation                 | (Note 5) | Ь                                | 0.75        | W    |  |
| Total Fower Dissipation                 | (Note 6) | P <sub>D</sub>                   | 1.2         |      |  |
| Thermal Resistance, Junction to Ambient | (Note 5) | В                                | 166         |      |  |
| Thermal Resistance, Junction to Ambient | (Note 6) | $R_{	hetaJA}$                    | 104         | °C/W |  |
| Thermal Resistance, Junction to Case    | (Note 6) | $R_{	heta JC}$                   | 35          |      |  |
| Operating and Storage Temperature Range |          | T <sub>J,</sub> T <sub>STG</sub> | -55 to +150 | °C   |  |

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

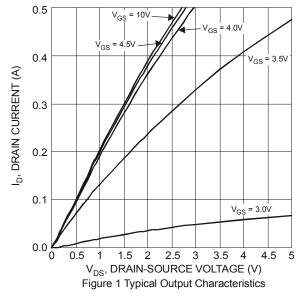
| Characteristic                     | Symbol               | Min | Тур   | Max  | Unit | Test Condition   |
|------------------------------------|----------------------|-----|-------|------|------|--|
| OFF CHARACTERISTICS (Note 7)       |                      |     |       |      |      |  |
| Drain-Source Breakdown Voltage     | BV <sub>DSS</sub>    | 240 | _     |      | ٧    | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA               |
| Zero Gate Voltage Drain Current    | I <sub>DSS</sub>     | _   | _     | 100  | nA   | V <sub>DS</sub> = 240V, V <sub>GS</sub> = 0V               |
| Gate-Body Leakage                  | I <sub>GSS</sub>     | _   | _     | ±100 | nA   | V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V               |
| ON CHARACTERISTICS (Note 7)        |                      |     |       |      |      |  |
| Gate Threshold Voltage             | V <sub>GS(th)</sub>  | 1.0 | 2.0   | 3.0  | >    | $V_{DS} = V_{GS}, I_D = 250 \mu A$                         |
| Static Drain-Source On-Resistance  | D                    |     | 3.7   | 11   | Ω    | $V_{GS} = 10V, I_D = 0.3A$                                 |
| Static Dialii-Source On-Resistance | R <sub>DS</sub> (ON) |     | 4.0   | 12   | 12   | $V_{GS} = 4.5V, I_D = 0.2A$                                |
| Diode Forward Voltage              | $V_{SD}$             | _   | 0.7   | 1.2  | V    | V <sub>GS</sub> = 0V, I <sub>S</sub> = 0.1A                |
| DYNAMIC CHARACTERISTICS (Note 8)   |                      |     |       |      |      |  |
| Input Capacitance                  | C <sub>iss</sub>     |     | 76.8  |      |      | V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V,<br>f = 1.0MHz |
| Output Capacitance                 | Coss                 | _   | 6.9   |      | pF   |  |
| Reverse Transfer Capacitance       | Crss                 |     | 4.1   | _    |      |  |
| Gate Resistance                    | Rg                   |     | 17    | _    | Ω    | V <sub>DS</sub> = 0V, V <sub>GS</sub> = 0V, f = 1.0MHz     |
| Total Gate Charge                  | Qg                   | _   | 3.7   | _    |      | 1001/1/  |
| Gate-Source Charge                 | Q <sub>gs</sub>      | _   | 0.3   | _    | nC   | $V_{DS} = 192V, V_{GS} = 10V,$ $I_{D} = 0.1A$              |
| Gate-Drain Charge                  | $Q_{gd}$             |     | 2.1   | _    |      | ID = 0.1A  |
| Turn-On Delay Time                 | t <sub>D(on)</sub>   |     | 4.8   | _    |      |  |
| Turn-On Rise Time                  | t <sub>r</sub>       | _   | 4.7   | _    |      | V <sub>DS</sub> = 120V, I <sub>D</sub> = 0.1A,             |
| Turn-Off Delay Time                | t <sub>D(off)</sub>  | _   | 17.5  | _    | nS   | $V_{GS} = 10V, R_G = 6.0\Omega$                            |
| Turn-Off Fall Time                 | t <sub>f</sub>       | _   | 102.3 | _    |      |  |
| Reverse Recovery Time              | t <sub>rr</sub>      |     | 45.6  |      | nS   | V <sub>R</sub> = 100V, I <sub>F</sub> = 1.0A.              |
| Reverse Recovery Charge            | Qrr                  | _   | 51.6  | _    | nC   | di/dt = 100A/µs  |

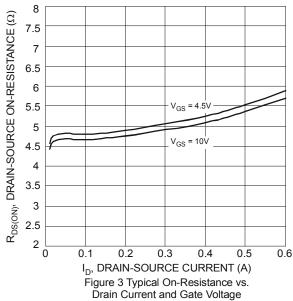
Notes:

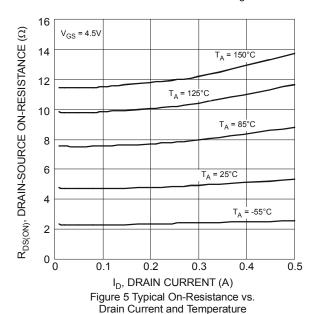
- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout
- 7 .Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.

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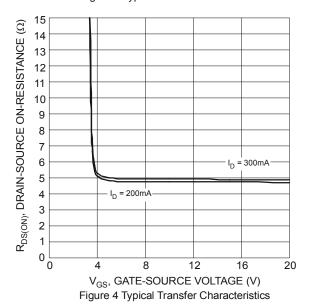








0.3 V<sub>DS</sub> = 5.0V 0.25 ID, DRAIN CURRENT (A) 0.2 0.15 0.1 T<sub>A</sub> = 125°C = 25°C 0.05 0 0 0.5 1.5 2 2.5 3.5 4 4.5 1 3 5  $V_{GS}$ , GATE-SOURCE VOLTAGE (V) Figure 2 Typical Transfer Characteristics



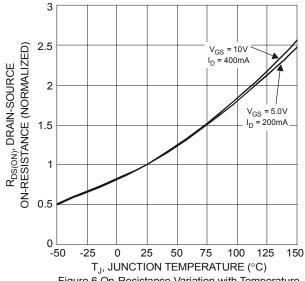
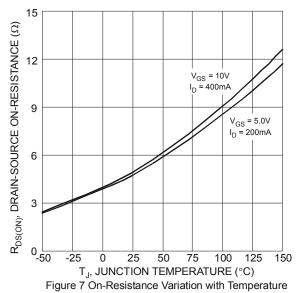
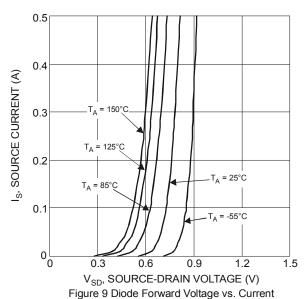
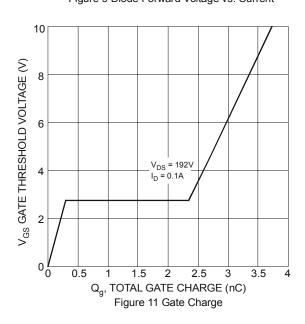


Figure 6 On-Resistance Variation with Temperature









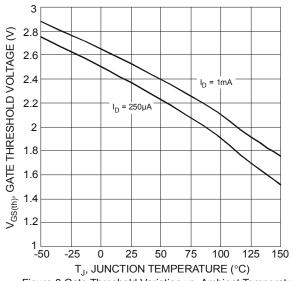
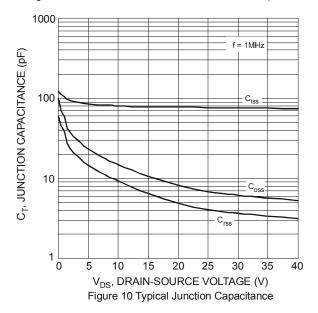
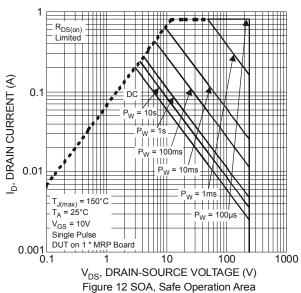
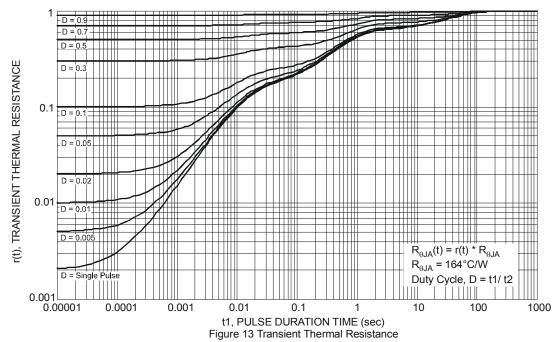


Figure 8 Gate Threshold Variation vs. Ambient Temperature



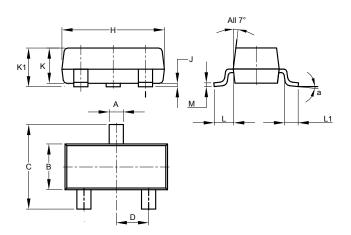






# Package Outline Dimensions

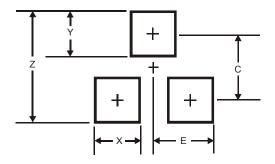
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| SOT23 |                      |      |       |  |  |  |  |  |
|-------|----------------------|------|-------|--|--|--|--|--|
| Dim   | Min                  | Max  | Тур   |  |  |  |  |  |
| Α     | 0.37                 | 0.51 | 0.40  |  |  |  |  |  |
| В     | 1.20                 | 1.40 | 1.30  |  |  |  |  |  |
| С     | 2.30                 | 2.50 | 2.40  |  |  |  |  |  |
| D     | 0.89                 | 1.03 | 0.915 |  |  |  |  |  |
| F     | 0.45                 | 0.60 | 0.535 |  |  |  |  |  |
| G     | 1.78                 | 2.05 | 1.83  |  |  |  |  |  |
| Н     | 2.80                 | 3.00 | 2.90  |  |  |  |  |  |
| J     | 0.013                | 0.10 | 0.05  |  |  |  |  |  |
| K     | 0.890                | 1.00 | 0.975 |  |  |  |  |  |
| K1    | 0.903                | 1.10 | 1.025 |  |  |  |  |  |
| L     | 0.45                 | 0.61 | 0.55  |  |  |  |  |  |
| L1    | 0.25                 | 0.55 | 0.40  |  |  |  |  |  |
| М     | 0.085 0.150 0.110    |      |       |  |  |  |  |  |
| а     | <b>a</b> 8°          |      |       |  |  |  |  |  |
| All   | All Dimensions in mm |      |       |  |  |  |  |  |

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



| Dimensions | Value (in mm) |  |  |  |
|------------|---------------|--|--|--|
| Z          | 2.9           |  |  |  |
| Х          | 0.8           |  |  |  |
| Υ          | 0.9           |  |  |  |
| С          | 2.0           |  |  |  |
| E          | 1.35          |  |  |  |



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